

LIQUID CRYSTAL DISPLAY MODULE

Product Specification

CUSTOMER	Standard
CUSTOMER PART NUMBER	
PRODUCT NUMBER	DET28QVF1J-A

Product Mgr	Design Eng
Bruno	Sunny
Date: 17-March-15	Date: 17-March-15

Product No.	DET28QVF1J-A	REV. 1.3	

rage II/20	Page	1/28	
------------	------	------	--



TABLE OF CONTENTS

1	IVI	MAIN FEATURES	4
2	М	MECHANICAL SPECIFICATION	5
	2.1 2.2		
3	EL	LECTRICAL SPECIFICATION	7
	3.1 3.2 3.3 3.4 3.5 3.6 3.7	ABSOLUTE MAXIMUM RATINGS ELECTRICAL CHARACTERISTICS INTERFACE PIN ASSIGNMENT BLOCK DIAGRAM TIMING CHARACTERISTICS COMMAND TABLE POWER SEQUENCE.	
4	OI	OPTICAL SPECIFICATION	16
	4.1	OPTICAL CHARACTERISTICS	16
5	BA	SACKLIGHT SPECIFICATION	18
	5.1 5.2	LED DRIVING CONDITIONSLED CIRCUIT	
6	TC	OUCH PANEL CHARACTERISTICS	19
	6.1 6.2 6.3	MECHANICAL CHARACTERISTICS	19
7	QI	QUALITY ASSURANCE SPECIFICATION	20
	7.1 7.2		_
8	RE	RELIABILITY SPECIFICATION	27
	8.1	RELIABILITY TESTS	27
9	Н	IANDLING PRECAUTIONS	28

Troduct No. DE125QV113 A NEV. 1.5	Product No. DET28QVF1J-A REV. 1.3 Page 2 / 28
-----------------------------------	---



REVISION RECORD

Rev.	Date	Page	Chapt.	Comment	ECN no.
1.0	24-Mar-14			First Issue	
1.1	03-Apr-14	4	1	Added RoHS compliance to 2011/65/EU	
1.2	26-Jun-14	4,5 19 21-25	1,2.1 6 7.1.6	Weight added Updated Touch Screen Panel Specification Updated Inspection Specification	
1.3	17-Mar-15	6	2.2	Updated thickness of touch FPC stiffener Updated touch surface to glare (glossy)	

Product No. DET28QVF1J-A REV	/ . 1.3
------------------------------	----------------

Pag	e	3 /	/ 28



1 MAIN FEATURES

ITEM	CONTENTS
Screen Size	2.8" Diagonal
Display Format	240 x RGB x 320 Dots
N° of Colour	262К
Overall Dimensions	49 mm (H) x 69 mm (V) x 3.26 mm (D)
Active Area	43.2 mm (H) x 57.6 mm (V)
LCD Type	TFT
Mode	MVA Transmissive / Normally White
Viewing Direction	Full view
Interface	80-series CPU 8/9/16/18 bit selectable
Driver IC	ILI9341V or equivalent
Backlight Type	LED
Touch Panel Type	4-Wire Resistive
Operating Temperature	-20°C ~ +70°C
Storage Temperature	-30°C ~ +80°C
RoHS compliant	2011/65/EU
Weight	19 g

	Product No.	DET28QVF1J-A	REV. 1.3	Page	4 / 28
--	-------------	--------------	----------	------	--------



2 MECHANICAL SPECIFICATION

2.1 MECHANICAL CHARACTERISTICS

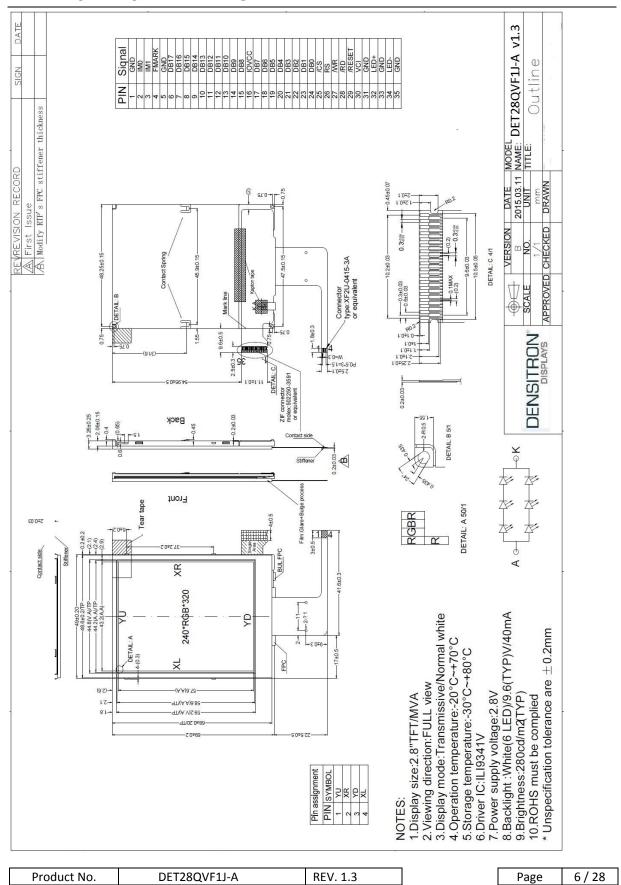
ITEM	CHARACTERISTIC	UNIT
Display Format	240 x RGB x 320 Dots	Dots
Overall Dimensions	49 mm (H) x 69 mm (V) x 3.26 mm (D)	mm
Viewing Area	43.2 (H) x 57.6 (V)	mm
Active Area	43.2 (H) x 57.6 (V)	mm
Dot Pitch	180 (H) x RGB x 180 (V)	μm
Weight	19	g

Product No.	DET28QVF1J-A	REV. 1.3	
-------------	--------------	----------	--

Page	5/2	8



2.2 MECHANICAL DRAWING





3 ELECTRICAL SPECIFICATION

3.1 ABSOLUTE MAXIMUM RATINGS

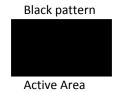
Item	Symbol	Condition	Min	Max	Unit	Note
Power Supply Voltage	IOVCC, VCI	Ta=25°C	-0.3	4.6	V	
Operating Temperature	ТОР		-20	70	°C	1
Storage Temperature	TST		-30	80	°C	1,2,3

- Note 1. 90 % RH Max for Ta<50 °C, and 60% RH for Ta≥50°C.
- Note 2. In case of below 0°C, the response time of liquid crystal (LC) becomes slower and the colour of panel becomes darker than normal one. Level of retardation depends on temperature, because of LC's characteristic.
- Note 3. Only operation is guaranteed at operating temperature. Contrast, response time, another display quality are evaluated at +25°C.

3.2 ELECTRICAL CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Max	Unit	Note
Complex Valtage	VCI		2.5	2.8	3.3	V	
Supply Voltage	IOVCC		1.65	2.8	3.3	V	
Input Voltage for Logic	VIH		0.7xIOVCC	-	IOVCC	V	
	VIL		GND	-	0.3xIOVCC	V	
Outrot Valtage for Laria	. VOH		0.8xIOVCC	-	IOVCC	V	
Output Voltage for Logic	VOL		GND	-	0.2xIOVCC	V	
Current Consumption	ICC		-	8.94		mA	1

Note 1: The specified power consumption is under the conditions of IOVCC=VCI=2.8V, FV=60Hz, whereas Power dissipation check pattern below is displayed.



Product No. DET28QVF1J-A REV. 1.3 Page 7 /	Product No.
--	-------------



3.3 INTERFACE PIN ASSIGNMENT

3.3.1 LCM PIN ASSIGNMENT

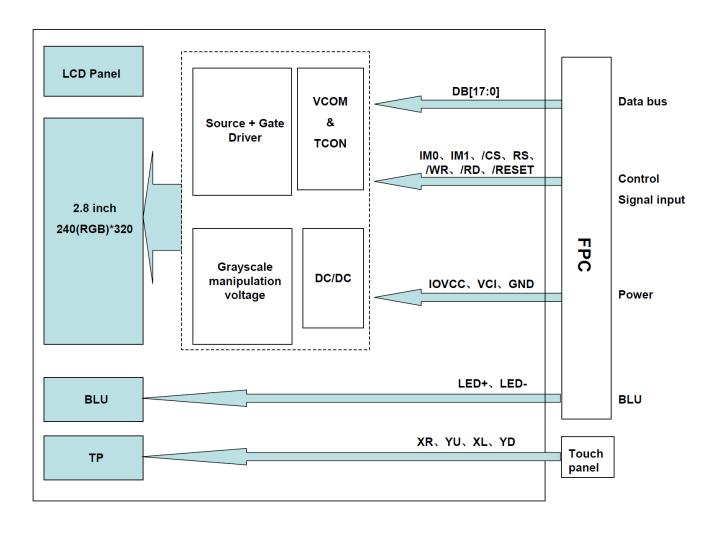
Recommended connector: Molex 502250-3591

Pin		Recommended connector: Molex 502250-3591					
No.	Symbol	Function					
1	GND	Ground					
2	IM0	IM1 IM0 Interface mode DB Pin in use				use	
3	IM1	80-series Register/Content GRA					
		0	0 0 CPU 16-bit D[8:1] D[
				Interface II		D[8:1]	
		0	1	CPU 8-bit I/F II	D[17:10]	D[17:10]	
		1	0	CPU 18-bit I/F II	D[8:1]	D[17-0]	
		1	1	CPU 9 bit I/F II	D[17:10]	D[17:9]	
4	FMARK (TE)	Frame	head	pulse signal	leave it Open if not	used)	
5	GND	Groun	d				
6	DB17	4					
7	DB16	_					
8	DB15						
9	DB14	Data b	us				
10	DB13	_					
11	DB12						
12	DB11	leanne	oct unu	sed pin(s) to VSS)			
13	DB10	COMME	ect unu	sea piri(s) to vss)			
14	DB9						
15	DB8						
16	IOVCC			r supply			
17	DB7	Data b	us				
18	DB6						
19	DB5						
20	DB4						
21	DB3	(conne	ect unu	sed pin(s) to VSS)			
22	DB2	_					
23	DB1	4					
24	DB0	ļ					
25	/CS (CSX)			gnal active low			
26	RS (DCX)	+	•	(RS=H) / Command	selection (RS=L)		
27	/WR (WRX)	+		active low			
28	/RD (RDX)	+		ictive low			
29	/RESET (RESX)			active low			
30	VCI			wer supply			
31	GND	Groun					
32	LED+			upply (+)			
33	GND	Groun					
34	LED-	LED power supply (-)					
35	GND	Groun	d				

		Product No.	DET28QVF1J-A	REV. 1.3		Page	8 / 28
--	--	-------------	--------------	----------	--	------	--------



3.4 BLOCK DIAGRAM



Product No.	DET28QVF1J-A	REV. 1.3		Page	9 / 28	l
-------------	--------------	----------	--	------	--------	---

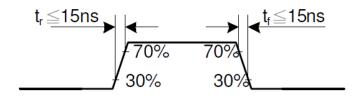


3.5 TIMING CHARACTERISTICS

Please refer to Ilitech IC ILI9341V datasheet for more information

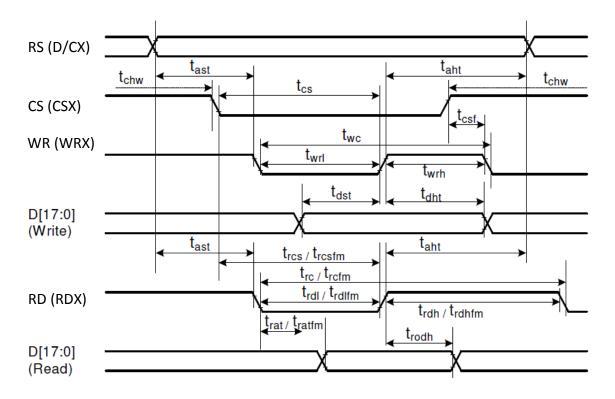
3.5.1 CPU 80-series Timing Characteristics (Interface II)

Item	Symb	ol	MIN	MAX	Unit	Remark
Address setup time	RS(DCX)	tast	0	-	Ns	
Address hold time (Write/Read)	K3(DCX)	taht	0	-	ns	
Chip select "H" pulse width		tchw	0	-	ns	
Chip select setup time (write)		tcs	15	-	ns	
Chip select setup time (Read ID)	CS(CSX)	trcs	45	-	ns	
Chip select setup time (Read FM)		trcsfm	355	-	ns	
Chip select Wait time (Write/Read)		tcsf	10	-	ns	
Write cycle		twc	66	-	ns	
Write Control pulse H duration	WR(WRX)	twrh	15	-	ns	
Write Control pulse L duration		twrl	15	-	ns	
Read cycle (FM)		trcfm	450	-	ns	
Read Control H duration (FM)	RD(RDX (FM))	trdhfm	90	-	ns	
Read Control L duration (FM)		trdlfm	355	-	ns	
Read cycle (ID)		trc	160	-	ns	
Read Control H duration	RD(RDX (ID))	trdh	90	-	ns	
Read Control L duration		trdl	45	-	ns	
Write data setup time	D[17:0], D[17:10] & D[8:1],	tdst	10	-	ns	For max
Write data hold time		tdht	10	-	ns	CL=30pF
Read access time		trat	-	40	ns	For min
Read access time (FM)	D[17:10],	tratfm	-	340	ns	CL=8pF
Read output disable time	D[17:9]	trod	20	80	ns	

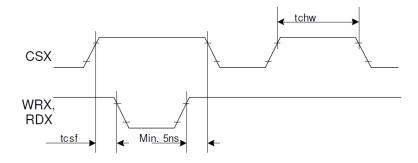


I	Product No.	DET28QVF1J-A	REV. 1.3	Page	10 / 28	İ
ı	FIDUUCLING.	DETZOQVE1J-A	NEV. 1.3	Page	10/20	1

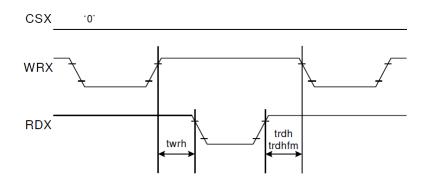




CS (CSX) timing:



Write to read or read to write timings [WR (WRX), RD (RDX)]:



Note: Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals.

Product No.	DET28QVF1J-A	REV. 1.3]	Page	11 / 28	
-------------	--------------	----------	---	------	---------	--



3.6 COMMAND TABLE

Operational Code (HEX)	Function	Read/Write / Command	Number of Parameter	Parameters
00	No Operation	С	0	-
01	Software Reset	С	0	-
04	Read Display Identification Information	R	3	
09	Read Display Status	R	4	
0A	Read Display Power Mode	R	1	
ОВ	Read display MADCTL	R	1	
0C	Read Display Pixel Format	R	1	
0D	Read Display Image Mode	R	1	
0E	Read Display Signal Mode	R	1	
OF	Read Display Self Diagnostic Result	R	1	
10	Sleep In	С	0	-
11	Sleep Out	С	0	-
12	Partial Mode On	С	0	-
13	Normal Display Mode On	С	0	-
20	Display Inversion Off	С	0	-
21	Display Inversion On	С	0	-
26	Gamma Set	W	1	format: 1byte for curve selection
28	Display Off	С	0	-
29	Display On	С	0	-
2A	Column Address Set	W	4	format: 2 byte for leftmost Column counter 2 byte for rightmost Column counter
2B	Page Address Set	W	4	format: 2 byte for top line pointer 2 byte for bottom line pointer
2C	Memory Write	W	Any length	Successive video data stream Format in all colour modes
2E	Memory Read	R	Any length	Successive video data stream Format in all colour modes
30	Partial Area	W	4	format: 2 byte for top line pointer 2 byte for bottom line pointer

Product No.	DET28QVF1J-A	REV. 1.3		Page	12 / 28
-------------	--------------	----------	--	------	---------



Operational Code (HEX)	Function	Read/Write / Command	Number of Parameter	Parameters
33	Vertical Scrolling Definition	w	6	format: 2 byte for fixed area top line pointer 2 byte for scrolling area height 2 byte for fixed area bottom line pointer
34	Tearing Effect Line Off	С	0	
35	Tearing Effect Line On	W	1	1 byte for Tearing Effect Line Mode selection
36	Memory Data Access Control	W	1	1 byte for memory scan direction
37	Vertical Scrolling Start Address	W	2	2 byte for line pointer
38	Idle Mode Off	С	0	-
39	Idle Mode On	С	0	-
3A	Interface Pixel Format	W	1	Refer to ILI9341V datasheet
DA	Read ID1	R	(1)	
DB	Read ID2	R	(1)	
DC	Read ID3	R	(1)	

Product No. DET28QVF1J-A REV. :	1.3	
---------------------------------	-----	--

Dago	13	/ 28
Page	1 12 /	/ 20



3.7 POWER SEQUENCE

IOVCC and VCI can be applied in any order.

VCI and IOVCC can be powered down in any order.

During power off, if LCD is in the Sleep Out mode, VCI and IOVCC must be powered down minimum 120msec after RESET has been released.

During power off, if LCD is in the Sleep In mode, IOVCC or VCI can be powered down minimum Omsec after RESET has been released.

CS can be applied at any timing or can be permanently grounded. RESET has priority over CS.

Note 1: There will be no damage to the display module if the power sequences are not met.

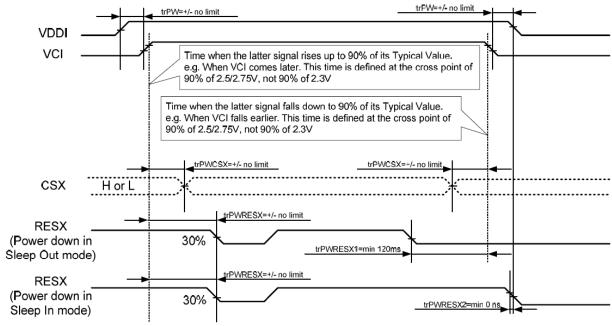
Note 2: There will be no abnormal visible effects on the display panel during the Power On/Off Sequences.

Note 3: There will be no abnormal visible effects on the display between end of Power On Sequence and before receiving Sleep Out command. Also between receiving Sleep In command and Power Off Sequence.

Note 4: If RESET line is not held stable by host during Power On Sequence as defined in Sections 3.7.1 and 3.7.2, then it will be necessary to apply a Hardware Reset (RESET) after Host Power On Sequence is complete to ensure correct operation. Otherwise function is not guaranteed.

3.7.1 Case 1 – RESET line is held High or Unstable by Host at Power ON

If RESET (RESX) line is held High or unstable by the host during Power On, then a Hardware Reset must be applied after both VCI and IOVCC have been applied – otherwise correct functionality is not guaranteed. There is no timing restriction upon this hardware reset.



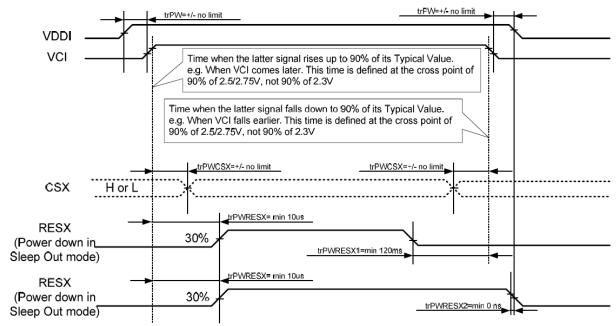
trPWRESX1 is applied to RESET (RESX) falling in the Sleep Out Mode trPWRESX2 is applied to RESET (RESX) falling in the Sleep In Mode

Product No. DET28QVF1J-A	REV. 1.3]	Page	14 / 28	
--------------------------	----------	---	------	---------	--



3.7.2 Case 2 – RESET line is held Low by Host at Power ON

If RESET (RESX) line is held Low (and stable) by the host during Power On, then the RESET must be held low for minimum 10µsec after both VCI and IOVCC have been applied.



trPWRESX1 is applied to RESET (RESX) falling in the Sleep Out Mode trPWRESX2 is applied to RESET (RESX) falling in the Sleep In Mode

3.7.3 Uncontrolled Power Off

The uncontrolled power off means a situation when e.g. there is removed a battery without the controlled power off sequence. There will not be any damages for the display module or the display module will not cause any damages for the host or lines of the interface. At an uncontrolled power off event, ILI9341V will force the display to blank and will not be any abnormal visible effects within 1 second on the display and remains blank until "Power On Sequence" actives.

For other settings and details please refer to ILI9341V data sheet.

	Product N	No. DET	28QVF1J-A	REV. 1.3		Page	15 / 28	
--	-----------	---------	-----------	----------	--	------	---------	--



4 OPTICAL SPECIFICATION

4.1 OPTICAL CHARACTERISTICS

Measuring instruments: LCD-5100, Eldim, Topcon BM-7 Driving condition: IOVCC = VCI = 2.8V, VSS = 0V

Backlight: IF=40mA Measured temperature: $Ta = 25^{\circ} C$

	Item	Symbol	Condition	MIN	ТҮР	MAX	Unit	Note
ı	Response Time TR+TF θ=Φ=0°		-	25	30	ms	2	
	Contrast Ratio	CR	Normal Viewing Angle	400	500	-		3
	Left	θL		60	75	-	deg	
Viewing Angle	Right	θR	CR ≥ 10	60	75	ı	deg	4
Viewin	Up	φU		60	75	ı	deg	
	Down	фD		60	75	-	deg	
	Red	Rx		0.599	0.649	0.699	-	
₹	Red	Ry		0.281	0.331	0.381	-	
Colour Chromaticity	Green	Gx		0.274	0.324	0.374	-	
no n	Green	Gy	CR ≥ 10	0.586	0.636	0.686	-] _
Ş	Blue	Вх	CR 2 10	0.092	0.142	0.192	-	5
nolo	blue	Ву		0.043	0.093	0.143	-	-
Ö	NA/la:t-a	Wx		0.257	0.307	0.357	-	
White	white	Wy		0.291	0.341	0.391	-	
Centr	e Brightness			220	280	-	cd/m²	6
Bright	ness Distribution			70	-	-	%	7

Product No. DET28QVF1J-A REV. 1.3 Page 16 / 28	Product No.
--	-------------



4.1.1 Test Method

Note	Item	Test method
1	Setup	The display should be stabilised at a given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilise the luminance, measurements should be executed after lighting the backlight for 30 minutes in a windless room. Display
2	Response time	Measure output signal waveform by the luminance meter when raster of window pattern is changed from white to black and from black to white. White Black White 100% 90% Black Black
3	Contrast ratio	Measure maximum brightness and minimum brightness at the centre of the screen by displaying raster or window pattern. Then calculate the ratio between these two values. Contrast Ratio (CR) = Brightness of unselected position (white)
4	Viewing angle Horizontal θ Vertical Ø	Move the luminance meter from right to left and up and down and determinate the angles where contrast ratio is 10 $8 = \varphi = 0^{\circ}$
5	Colour chromaticity	Measure chromaticity coordinates x and y of CIE1931 colorimetric system
6	Centre brightness	Measure the brightness at the centre of the screen
7	Brightness distribution	(Brightness distribution)= 100 x B/A % A: max. brightness of the 9 points B: min. brightness of the 9 points

Product No.	DET28QVF1J-A	REV. 1.3	Page	17 / 28	i
i i oddet i vo.	DE120QVI 13 A	IVE 4. T.O	I ugc	1 1 / 20	i



5 BACKLIGHT SPECIFICATION

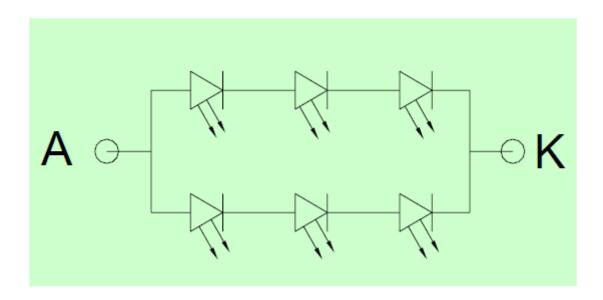
5.1 LED DRIVING CONDITIONS

Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Current	IF	Ta=25 °C, VF=3.2V/LED	-	20*2	-	mA
Forward Voltage	VF	Ta= 25°C, IF= 20mA/LED	3.0*3	3.2*3	3.4*3	V
Power Consumption	PBL	Ta= 25°C, IL= 40mA	-	384	-	mW
Estimated Life t	LL	Ta= 25°C, IF= 40mA Note	(20000)	-	-	Hr
LED configuration	6 white LEDs (3 LEDs in one string and 2 groups in parallel)					

Note:

- The lifetime of the LED is defined as a period till the brightness of the LED decreases to the half of its initial value.
- This figure is given as a reference purpose only, and not a guarantee.
- This figure is estimated for an LED operating alone.
 The performance of an LED may differ when assembled as a monitor together with a TFT panel due to different environmental temperature.
- Estimated lifetime could vary on a different temperature and usually higher temperature could reduce the life significantly.

5.2 LED CIRCUIT



Product No.	DET28QVF1J-A	REV. 1.3		Page	18 / 28	
-------------	--------------	----------	--	------	---------	--



6 TOUCH PANEL CHARACTERISTICS

6.1 ELECTRICAL CHARACTERISTICS

Item	Min.	Тур.	Max.	Unit	Note
Linearity	-1.5	-	1.5	%	Analogue X and Y direction
Terminal Resistance	150	-	550	Ω	X(Film side)
Terminal Resistance	300	-	850	Ω	Y(Glass side)
Insulation Resistance	20	-	-	ΜΩ	DC<10V
Voltage	-	5	10	V	DC
Chattering	-	-	10	ms	
Transmittance	78	-	-	%	

Caution1: Do not operate with a thing except a polyacetal pen (tip R0.8mm or less) or a Finger, especially those with hard or sharp tips such as ball point pen or a mechanical pencil.

6.2 MECHANICAL CHARACTERISTICS

Item	Min.	Тур.	Max.	Unit	Note
Activation force	-	-	150	g	(1)
Durability-surface	Write 20,000	-	-	Characters	(2)
scratching					
Durability-surface	1,000,000	-	-	touches	(3)
pitting					
Surface hardness	3	-	-	Н	

Note: (1) Stylus pen input: R0.8mm polyacetal pen or finger.

(2) Measurement for surface area.

- Force: 150-250gf - Speed: 60mm/sec

- Stylus: R0.8mm polyacetal pen or finger.

(3) Pit 1,000,000 times on the film with a R3.75 silicon rubber.

Force: 2.45NSpeed: 3 times/sec

6.3 TOUCH PANEL PIN ASSIGNMENT

No.	Symbol	Function
1	YU	Touch Panel Terminal
2	XR	Touch Panel Terminal
3	YD	Touch Panel Terminal
4	XL	Touch Panel Terminal

Recommend connector: OMRON XF2U-0415-3A

Product No.	DET28QVF1J-A	REV. 1.3		Page	19 / 28
-------------	--------------	----------	--	------	---------



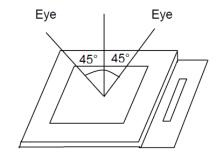
7 QUALITY ASSURANCE SPECIFICATION

7.1 DELIVERY INSPECTION STANDARDS

7.1.1 Inspection Conditions

Inspection distance: 30 cm ± 2 cm

Viewing angle: ±45°



7.1.2 Environmental Conditions

Ambient temperature: $23^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Ambient humidity: $55\pm 10\% \text{ RH}$ Ambient illumination: $1000^{\sim}1500 \text{ lux}$

7.1.3 Sampling Conditions

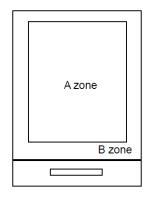
1. Lot size: quantity of shipment lot per model

2. Sampling method:

Sampling Plan		ANSI / ASQC Z1.4-1993
		Normal inspection, Single Sampling
401	Major Defect	0.65%
AQL	Minor Defect	1.5%

7.1.4 Definition of Area

A zone: active area B zone: viewing area



7.1.5 Basic Principle

A set of sample to indicate the limit of acceptable quality level shall be discussed should a dispute occur.

Product No.	DET28QVF1J-A	REV. 1.3]	Page	20 / 28
-------------	--------------	----------	---	------	---------



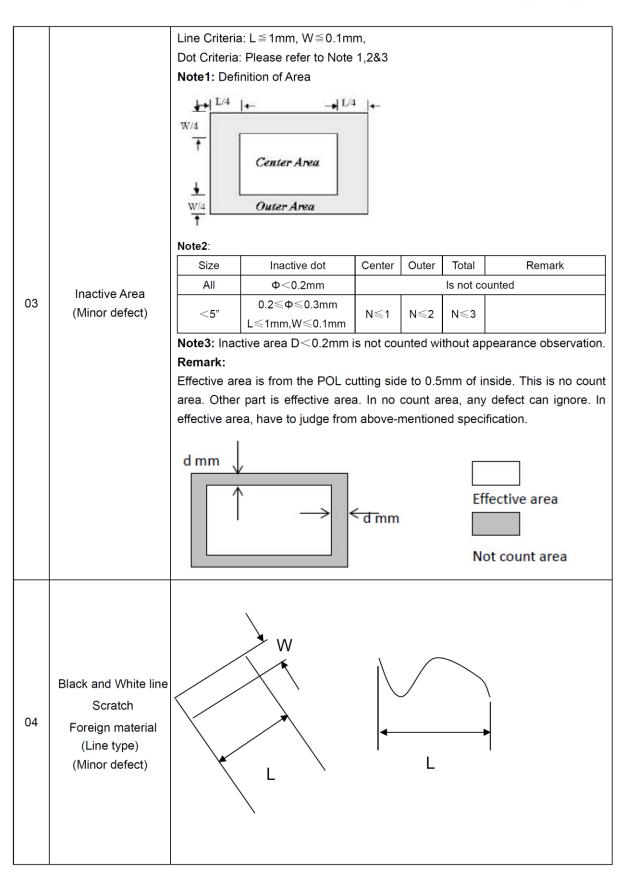
7.1.6 Inspection Criteria

No.	Item			Criteria (U	Init: mm)			
01	Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect)	φ= (a + b) /2		Size φ≤0 0.10<φ≤ 0.15<φ≤ 0.25-	≤0.15 ≤0.25 <φ	2 no	Acc. Qty Ignore 2 1 0 include φ	≤ 0.10
02	Electrical Defect	Bright dot Dark dot Total dot	Displ	ay Area 0 I≤2 I≤2	To: C N N N	tal) ≤2 ≤2	Note1	
	(Minor defect)	Remark: 1. Bright dot cau		risible through			Note 2	m 1.

Product No.	DET28QVF1J-A	REV. 1.3	

Page	21	/ 28
------	----	------





Product No.	DET28QVF1J-A	REV. 1.3	Page	22 / 28	

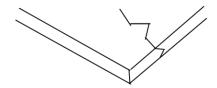


Length	Width	Acc. Qty
1	W ≦ 0.03	Ignore
L ≦ 2.5	0.03 < W ≤ 0.05	3
L ≦ 2.5	$0.05 < W \le 0.10$	2
/	0.1 < W	0
	Total	3

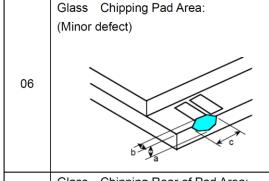
Distance between 2 defects should more than 3mm apart. Scratches not viewable through the back of the display are acceptable.

05 Glass Crack (Minor defect)

07

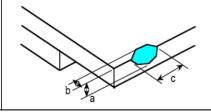


Crack is potential to enlarge, any type is not allowed.



Length and Width	Acc. Qty		
c > 3.0, b< 1.0	1		
c< 3.0, b< 1.0	3		
a <glass td="" thickness<=""></glass>			

Glass Chipping Rear of Pad Area: (Minor defect)



Length and Width	Acc. Qty	
c > 3.0, b< 1.0	1	
c< 3.0, b< 1.0	2	
c< 3.0, b< 0.5	4	
a <glass td="" thickness<=""></glass>		

Product No. DET28QVF1J-A REV. 1.3

Page	23	/ 28
1 age	23	20



	Glass Chipping Except Pad Area:	
	(Minor defect)	Length and Width Acc. Qty
		c > 3.0, b< 1.0
08		c< 3.0, b< 1.0 2
		c< 3.0, b< 0.5 4
	" >	a <glass td="" thickness<=""></glass>
	a	
	Glass Corner Chipping: (Minor defect)	
		Length and Width Acc. Qty
		c < 3.0, b< 3.0 Ignore
09		a <glass td="" thickness<=""></glass>
	barren	
10	Glass Burr: (Minor defect)	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$
11	FPC Defect: (Minor defect)	11.1 Dent, pinhole width a <w (w:="" 11.2="" 11.3="" 3.="" and="" circuit="" circuitry="" contamination="" distortion.<="" is="" no="" open="" oxidation,="" td="" unacceptable.="" width.)=""></w>

Product No.	DET28QVF1J-A	REV. 1.3	Page	24 / 28	



		Г	Diameter	Acc. Qty]
	Bubble on Polarizer		φ≤0.20	Ignore	1
12	(Minor defect)		0.20 <φ≤0.30	4]
	(minor develop		0.30 <φ≤0.50	1]
			0.50 < φ	None	
		_		**************************************	1
		_	Diameter	Acc. Qty	
10	Dent on Polarizer	_	φ≤0.20	Ignore	
13	(Minor defect)		0.20 <φ≤0.30	4	1
	(<u> </u>	0.30 <φ≤0.50	1	1
		L	0.50 < φ	None]
14	Bezel	14.1 No rust, distorti 14.2 No visible finge	on on the Bezel. rprints, stains or other	contamination.	
		D: Diameter W: wid	dth L: length		
		15.1 Spot: D<0.25 is	acceptable		
		0.25≤D≤	≤0.4		
		2dots are acceptabl	e and the distance be	tween defects	should more than 10
		mm.			
15	Touch Panel		unacceptable		
15	Touch Panel	15.2 Dent: D>0.40 is			
			03, L≤10 is acceptable		
		12.32	V≤0.10, L≤10 is acce	Ö.	
		Distance between 2	defects should more th		
			W>0.10 is unacce	ptable.	
		Touch the touch pan	el, cannot see the LCI) ripple.	
16	LCD Ripple	Pen: R 0.8mm silico			
		Operation Force:150)g		
		17 1 No distortion or	contamination on PCE	R terminals	
			nts on PCB must sa		nented on the
17	PCB	BOM/component lay		ame as accan	ichted on the
		17.3 Follow IPC-A-6	00F.		
18	Soldering	Follow IPC-A-610C	standard		
		The below defects m	nust be rejected.		
	Electrical Defect	19.1 Missing vertical	/ horizontal segment,		
19	(Major defect)	19.2 Abnormal Displ	ау.		
	(2,2. 43.000)	19.3 No function or r	no display.		
		19.4 Current exceed	s product specification	S.	

Dona donat Nia	DET200VE41 A	DEV 4.2	7	D	25 / 20
Product No.	DET28QVF1J-A	REV. 1.3		Page	25 / 28



7.1.7 Classification of Defects

Visual defects (except no or wrong label) are treated as minor defects, while electrical defects are treated as major defects.

Two minor defects are equal to one major defect in lot sampling inspection.

7.1.8 Identification / marking criteria

Any unit with illegible / wrong / double or no marking / label shall be rejected.

7.2 DEALING WITH CUSTOMER COMPLAINTS

7.2.1 Non-conforming analysis

Purchaser should supply Densitron with detailed data of non-conforming sample. After accepting it, Densitron should complete the analysis in two weeks from receiving the sample.

If the analysis cannot be completed on time, Densitron must inform the purchaser.

7.2.2 Handling of non-conforming displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of non-conforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

Product No.	DET28QVF1J-A	REV. 1.3		
-------------	--------------	----------	--	--



8 RELIABILITY SPECIFICATION

8.1 RELIABILITY TESTS

	Test Item	Test Condition
	High Temperature Storage	Ta= 80°C 96h
st	Low Temperature Storage	Ta=-30°C 96h
Durability Test	Temperature Cycle Storage	-30°C for 30 min, then 80°C for 30 min, 10 cycles
rabili	High Temperature Operation	Tp= 70°C 96h
DO	Low Temperature Operation	Tp= -20°C 96h
	High Temperature & Humidity Operation	Tp= 60°C RH= 90% 96h Non condensing
	Packaging vibration	Frequency range: 10Hz ~ 55Hz Amplitude of vibration: 1.5 mm Sweep time: 12 minutes X,Y,Z 2 hours in each direction
	Electrical Static Discharge	Air: ±4kV 150pF / 330Ω 5 times
Licentical Static Discharge		Contact: ±2kV 150pF / 330Ω 5 times
		To be measured after dropping from 80cm high on concrete surface in packing state.
		Corner dropping A corner: once
	Drop Test	Edge dropping
		B, C, D edge: once
		Face dropping Face dropping
		E, F, G face: once

Note: Ta=ambient temperature Tp= Panel temperature

Notes:

- 1. No dew condensation to be observed.
- 2. The function test shall be conducted after 4 hours storage at the normal temperature and humidity after removed from the test chamber.
- 3. No cosmetic or functional defects should be allowed.
- 4. Total current consumption should be less than twice the initial value.

Product No. DE128QVF1J-A REV. 1.3 Page 27/7	Product No.	DET28QVF1J-A	REV. 1.3		Page	27 / 28
---	-------------	--------------	----------	--	------	---------



9 HANDLING PRECAUTIONS

Safety

If the LCD panel breaks, be careful not to get the liquid crystal fluid in your mouth or in your eyes. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and plenty of water.

Mounting and Design

Place a transparent plate (e.g. acrylic, polycarbonate or glass) on the display surface to protect the display from external pressure. Leave a small gap between the transparent plate and the display surface.

When assembling with a zebra connector, clean the surface of the pads with alcohol and keep the surrounding air very clean.

Design the system so that no input signal is given unless the power supply voltage is applied.

Caution during LCD cleaning

Lightly wipe the display surface with a soft cloth soaked with Isopropyl alcohol, Ethyl alcohol or Trichlorotriflorothane.

Do not wipe the display surface with dry or hard materials that will damage the polariser surface. Do not use aromatic solvents (toluene and xylene), or ketonic solvents (ketone and acetone).

Caution against static charge

As the display uses C-MOS LSI drivers, connect any unused input terminal to VDD or VSS. Do not input any signals before power is turned on. Also, ground your body, work/assembly table and assembly equipment to protect against static electricity.

Packaging

Displays use LCD elements, and must be treated as such. Avoid strong shock and drop from a height. To prevent displays from degradation, do not operate or store them exposed directly to sunshine or high temperature/humidity.

Caution during operation

It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life. Direct current causes an electrochemical reaction with remarkable deterioration of the display quality. Give careful consideration to prevent direct current during ON/OFF timing and during operation. Response time is extremely delayed at temperatures lower than the operating temperature range while, at high temperatures, displays become dark. However, this phenomenon is reversible and does not mean a malfunction or a display that has been permanently damaged. If the display area is pushed on hard during operation, some graphics will be abnormally displayed but returns to a normal condition after turning off the display once. Even a small amount of condensation on the contact pads (terminals) can cause an electro-chemical reaction which causes missing rows and columns. Give careful attention to avoid condensation.

Storage

Store the display in a dark place where the temperature is $25^{\circ}\text{C} \pm 10^{\circ}\text{C}$ and the humidity below 50%RH. Store the display in a clean environment, free from dust, organic solvents and corrosive gases.

Do not crash, shake or jolt the display (including accessories).

Product No.	DET28QVF1J-A	REV. 1.3	Page	28 / 28	l